

Product/Process Change Notifications



PCN - 15 028

Release Date: May 07 2015

Product Name:	ExaMEZZ and Combo power		
	PCB		
Product Manager:	Bruce Liu		
Subject:	Notification of Change with Immediate Effectivity		
Distribution:	General		
Type of Change:	Documentation Change		
Change Description:	Change the Cu plating thickness of printed circuit board from 0.025-0.050um to 0.020-0.050um.		
Reason for Change:	FCI was requested by a specific customer to modify the recommended Cu plating thickness of printed circuit board. This was to meet the IPC-2221A Generic standard on printed board design in order to satisfy the feasibility of PCB plating. There is no change to actual product. The change happens only recommended PCB spec.		
Affected Parts:	Attached list.		
Effective Date of Change:	August 7, 2015		
Last Time Buy Date:	NA		
Last Disty Return Date:	NA		
Last Time Shipment Date	NA		
Datasheet Attached?	Yes		
Qual/Test Data Attached?	NA		
Samples Availability Date:	May	7	2015
Available Alternatives?	N/A		
Questions?	<i>Contact your local FCI Representative, or Product Manager</i>		
	<i>Bruce Liu/ Product Manager</i>		
	<i>Bruce.Liu@fci.com</i>		

Note:

Customer shall intimate the product Manager any Concern regarding the PCN within 3 weeks of the release date. PCN is considered approved by the customer if no communication is received within 3 weeks